

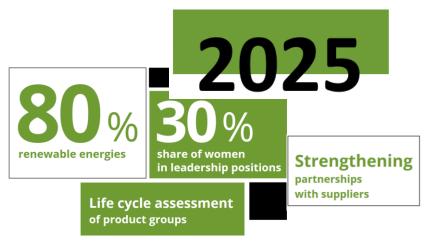
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www.ats.net

Driving sustainability



High level of social, ecological and economic responsibility



Achievements¹

- Share of renewable energies of 47%²
- Share of women in leadership positions of 19%
- Innovation revenue rate of 21%
- 95% of suppliers signed our Code of Conduct
- as of 31.12.2020
- ² including big hydro power

Rated by			
SUSTAINALYTICS	Outperformer 2019 Overall Score: 77		
ISS ESG ⊳	Prime 2020 Corporate Responsibility: B-		
MSCI 🛞	BBB 2021 ESG rating		
CDP	Climate Change Water Security 2020: B- 2020: B Management Management		

Datad by

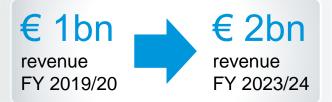


Leading provider of high-end PCBs and IC substrates

Well positioned for the future

2
high-end PCB
producer worldwide

5
ABF substrates in FY 2024/25



Unique market position

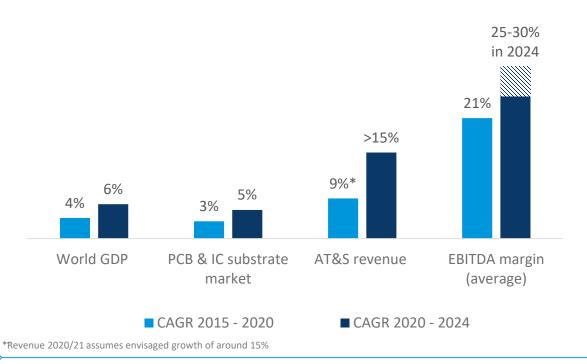
- Broad product portfolio to serve all growth markets
- Long-standing customer relationships with technology and market leaders
- Technology innovator due to continuous R&D efforts
- Quality benchmark with outstanding process know-how, productivity and efficiency

Growth oriented strategy

- Megatrend-driven markets with attractive growth potential
- Address growth opportunities with incremental investments

An exciting growth story

AT&S with faster revenue growth than market





Growing profitably with served markets





 IC substrates/modules: 11% market growth until 2025



Growing market

- Technology leadership
- Operational excellence
- Strong customer engagement
- Clear focus on dedicated applications

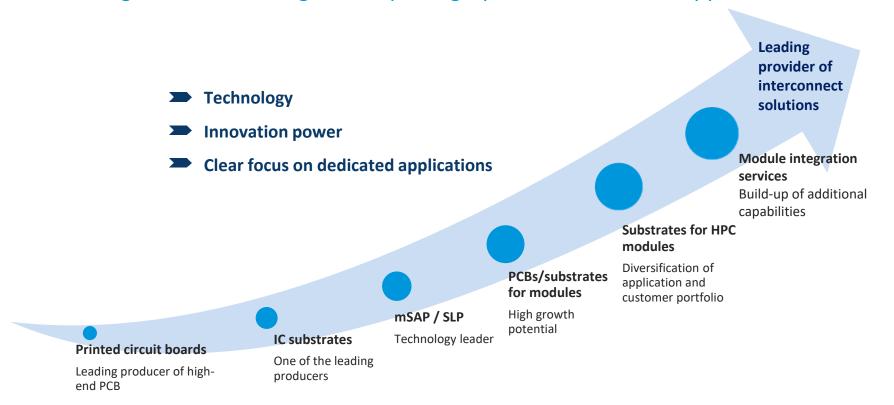
Strategy in execution

- IC substrates full expansion of capacities in CHQ I
- High-end PCBs full expansion of capacities in CHQ II
- IC substrates build-up of new capacities in CHQ III
- Further developing of PCB business to serve trends of modularization and miniaturization





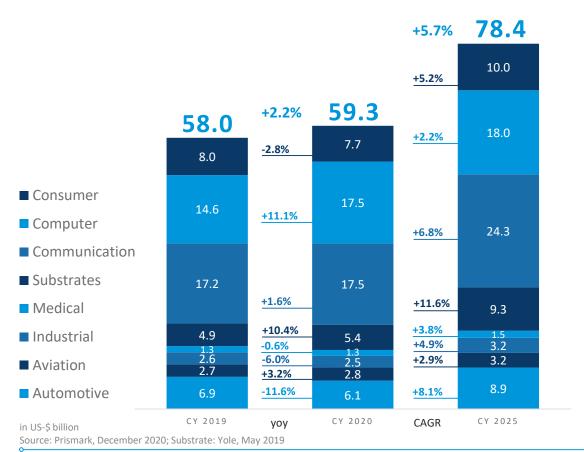
Broadening the service range and opening up of new business opportunities





PCB & IC substrates market outlook





+2.2%

There was market growth even in the COVID year 2020

+5.7% CAGR

All adressed markets show positive growth rates over the mid-term

AT&S will outperform the market with an annual growth of

>15% until 2025

Digitalisation is accelerating

AT&S

Growth in various areas



Server ICs in Data Centres (10% CAGR 2020-2025)

2019 42.5 million units
 2020 46.5 million units
 2025 75.3 million units



5G Base Station (25% CAGR 2020-2025)

2019 0.16 million units
 2020 1.09 million units
 2025 3.35 million units



Total Smartphone Market (3% CAGR 2020-2025)

2023

5G Smartphones (+34% CAGR 2020-2025)

2020 1,280 million units
2025 1,540 million units
2019 16 million units
2020 241 million units
2025 1,046 million units

1,370 million units

Sources: Yole, Dec. 2020; ABI, Jan 2020, IDC 2020, AT&S estimates 01/2021

AT&S - 13th Digital Austrian Equity Days

2019



Capacity expansion in Chongqing

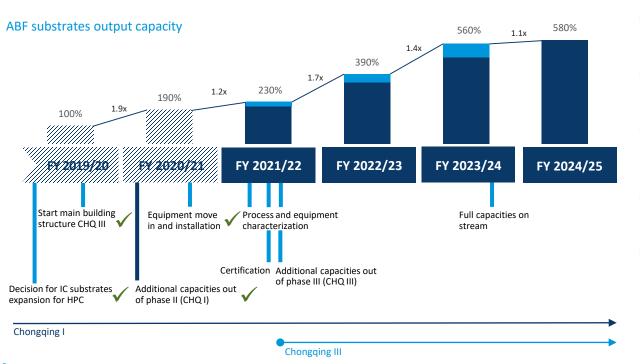
On the way to becoming one of the leading high-end ABF substrates producers



Growing demand for ABF substrates drives capacity expansion



Chongqing I and III excellently executed



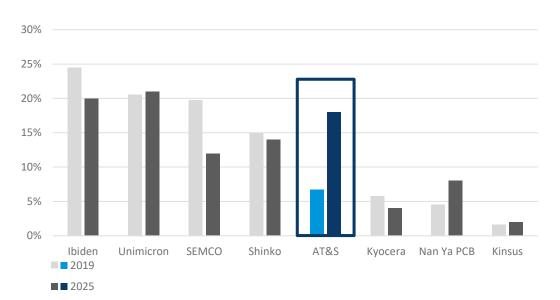
- CHQ I: Running on full capacity since Q3 2020/21
- CHQ III: Currently in the installation and qualification phase
- Production will already be starting in FY 2021/22
- Additional € 200 M investment in CHO III
- Full capacities available with the beginning of CY 2024 (Q4 2023/24)
 - Additional output capacity due to investment increase and earlier production start in CHQ III



Top-8 global ABF* substrates suppliers

AT&S expects to enter the top-league of ABF substrates suppliers and significantly increase output capacity by 2025

Output capacity by company (based on US-\$)



- ABF is the state-of-the-art production process for high-end IC substrates with high growth potential
- With current investments, AT&S will rise to the top three ABF suppliers globally by 2025

Source: Prismark, JMS, AT&S assessment

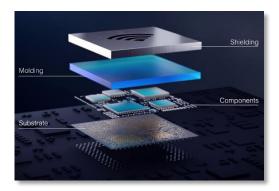
^{*}ABF: Ajinomoto Buildup Film

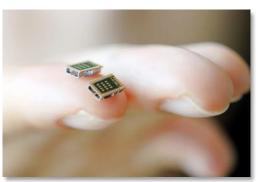
Module business





New opportunities through entry into the module market





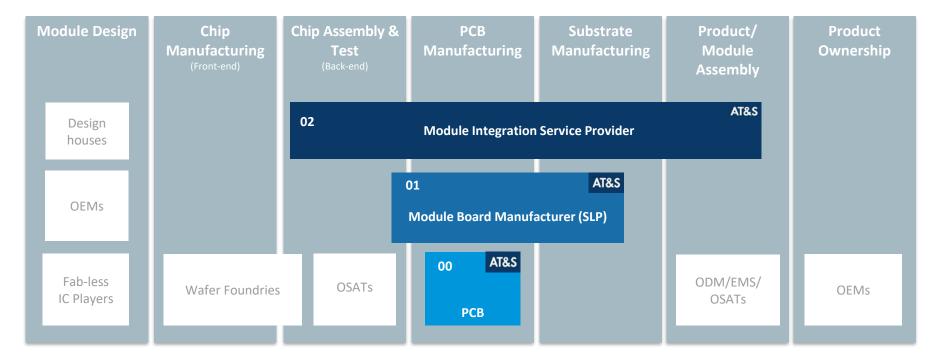
- Module integration market growing by 11%
 annually until 2025
- Total investment Chongqing II in module business of about € 160 million
- Extension of application and customer portfolio
- Module PCB/substrates expected to reach ~5 10% of group revenues within the next two years
 - For FY 2020/21 already double-digit million revenue expected

Main applications include PCBs for RF/5G modules, power modules and wearables

Increase in added value through additional design, assembly and test services



AT&S solutions for the electronics industry





Global market development



Accelerated digitalisation is driving electronics market

- Rising data traffic, Internet of Things and enhanced connectivity are pushing digital networking across all areas of life and work
- ABF substrates market continues with strong demand and limited capacity
- Mobile devices market supported by introduction of new 5G smartphone models in Q3
- Automotive market shows further recovery in Q3
- Industrial market moderate
- Medical market stable with positive demand for special applications

Development in Q1-3 2020/21



Highest ever generated revenue despite difficult economic situation

- IC substrates business profits from completed ramp-up of new capacities in CHQ I and ongoing strong demand for ABF substrates
- Mobile applications positively influenced by solid smartphone launch, customer and application diversification
- PCBs for modules experience growing demand
- Automotive shows further sequential improvement and Q3 already flat yoy
- Increased demand in Medical & Healthcare in Q3 compensates for restrained development in H1
- Industrial segment profits from better product mix

Revenue and EBITDA development





- Highest ever quarterly and YTD revenue despite slightly negative FX effects
- EBITDA increased to € 186.7 million (PY: € 156.4 million) mainly supported by higher revenues out of Chongqing plants
- Net profit higher at € 37.3 million (PY: € 25.2 million) despite unfavourable FX effects and negative interest result
- Operating free cash flow at € -127.5 million (PY: € 31.2 million) driven by higher investment activity

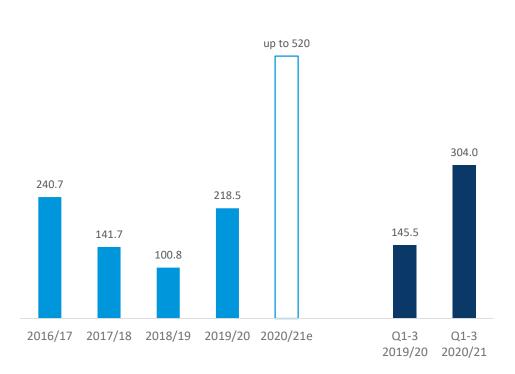
Revenue EBITDA — EBITDA margin

in € million

Net CAPEX



Investments in IC substrates and module PCBs consistently continued



Capex outlook 2020/21

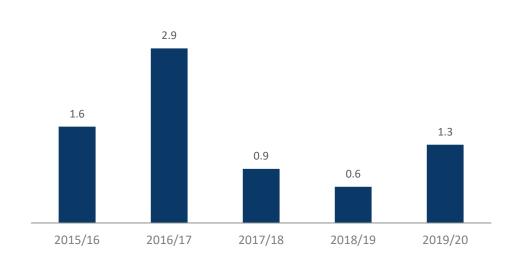
- Depending on market developments CAPEX for maintenance and tech upgrade of up to € 80 million
- CAPEX for strategic projects of up to € 410 million plus € 30 million due to timing variances

in € million

Solid finance structure



Net debt/EBITDA



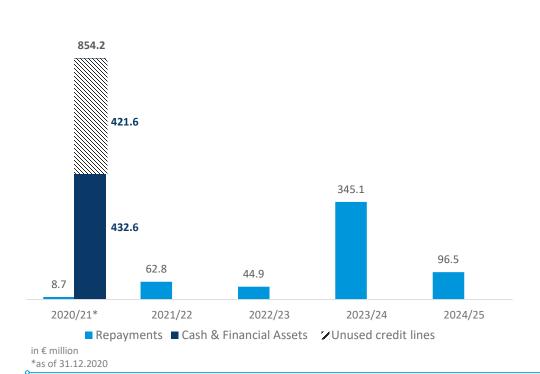
Existing funds and cash flow generation help to meet repayments and capex needs

< 3

Net debt / EBITDA target

Maturity profile





- > 854.2 million € of existing liquid funds*
 - Cash: € 393.9 million
 - Financial assets: € 38.7 million
 - Unused credit lines of € 421.6 million



Outlook for 2020/21

AT&S

Full-year guidance increased

- Digital change will speed up and further pervade all areas of life
- Expectations for the current year
- Ongoing strong demand for ABF substrates and continuing market capacity shortage
- Mobile Devices with usual seasonality in Q4
- Positive trend in Automotive continues with Q4 expected flat yoy
- Slight growth expected for Industrial and Medical segment
- Full-year guidance updated due to strong Q1-3 and improved visibility
 - Revenue growth of 17 to 19% (before: around 15%)
 - EBITDA margin in the range of 20 to 22%
- Investment programme unchanged with up to € 520 million for FY 2020/21

Medium-term guidance 2024/25



Technology development to module integration and capacity expansion

First choice for advanced applications

Expansion of technology leadership

- Leading provider of new interconnect solutions
- Innovation revenue rate: > 20%

Revenue and EBITDA target already reached in 2023/24

- Revenue target of more than € 2 billion
- Pursuing of sustainable margin improvement
- Medium-term EBITDA margin target of 25-30%

Creation of shareholder value and robust financial structure

- Medium-term ROCE above 12%
- Net debt / EBITDA: < 3 / Equity ratio: > 40% / Average Finance costs: < 2%</p>

Sustainability management

- 80% renewable energy
- Eco-balancing of product groups
- 30 % women in management positions



Market Segments & Product Applications





Mobile devices

- Smartphones
- Wearables
- Notebooks
- Cameras
- Tablets
- SSDs



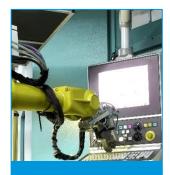
IC substrates

- Data centres
- Microservers
- Client PCs
- Edge computing
- 5G base stations



Automotive

- ADAS
- Sensoric (radar, lidar, camera, V-to-X communication)
- E-mobility (power supply for motor systems)



Industrial

- Smart building, lighting, manufacturing, transportation...
- Telecom infrastructure
- Power management
- Robots & drones



Medical

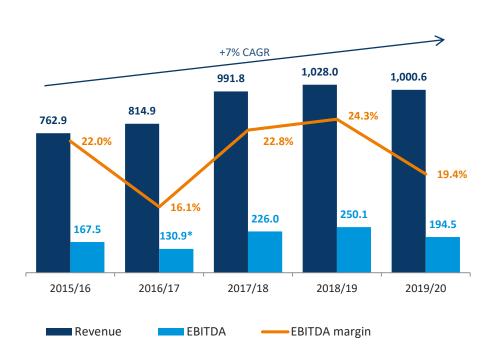
- Diagnostics and imaging systems
- Therapy application (pacemakers, hearing aids, drug delivery...)
- Patient monitoring

Segment Mobile Devices & Substrates

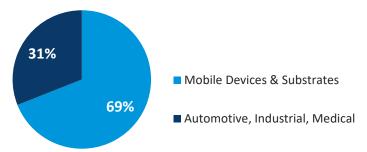
Segment Automotive, Industrial, Medical

Key facts FY 2019/20



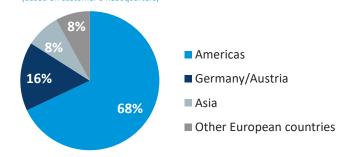


Revenue split by segment: FY 2019/20



Revenue split by customer: FY 2019/20

(based on customer's headquarters)



€ in million

^{*}Based on ramp-up effects for new plants in China





*Staff, Average, FTE, Q1-3 2020/21; 80 employees in other locations

Market players in the high-end segment



Market position HDI Technology (2019)

Rank	Supplier	Country/Region	HDI (revenue in US-\$ millions)
1	Compeq	TWN	776
2	AT&S	AUT	736
3	TTM	USA	716
4	Unimicron	TWN	706
5	Tripod	TWN	508
6	Meiko	JPN	461
7	Zhen Ding	TWN	428
8	Korea Circuit	KOR	227
9	Founder PCB	CHN	222
10	СМК	JPN	220

Source: Prismark, AT&S Market Intelligence

AT&S - Stock Profile



Listing: Vienna Stock Exchange,

Prime Standard

Indices: ATX, Vönix, WBI

Thomson Reuters (A): ATSV.VI

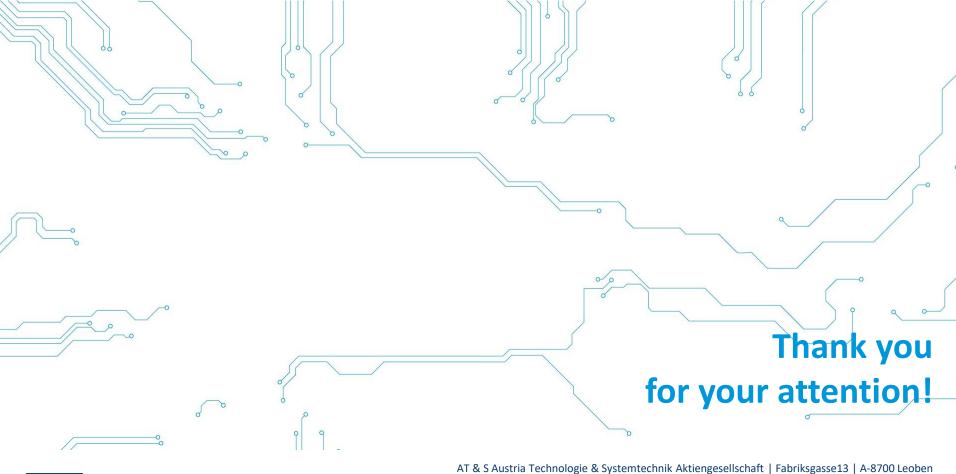
Bloomberg (A): ATS:AV

of shares outstanding 38.85m

Dividend for 2019/20:

€ 0.25 per share





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